

Bill of Materials

TI DESIGNS

TIDM-SOMPIC-G3-CENELEC

Item Number	Part Number	Quantity	Part Type	Part Reference	Vendor	Vendor PN	Description	Value	PCB Footprint	Tolerance	Voltage	Distributor Part Number	Distributo	CrossRef
1	100-00003	3	CAP	C1 C4 C5	AVX	0603YC104KAT*A	Capacitor 0.1UF 16 V 10 % X7R 0603	0.1UF	C0603	10%	16V	478-1239-2-ND	Digikey	
2	300-00017	2	CAP	C2 C3			Cap Ceramic SMT 0402	3n3F	C0402	0	10V			
3	300-00056	2	CAP	C6 C7	MURATA	GRM1555C1H150JZ01D	CAP CER 15PF 50V 5% C0G 0402	15pf	C0402	0	50V	490-1280-1-ND	Digikey	
4	300-00038	1	CAP	C8	PANASONIC	ECH-U1H332JX5	CAP .0033UF 50V PPS FILM 1206 5%	3n3F	C1206	0	50V	PCF1334CT-ND	Digikey	
5	300-00013	1	CAP	C9			Cap Ceramic SMT 0402	10nF	C0402	0	10V			
6	300-00085	2	CAP	C10 C11	Yageo	CC0805KRX7R9BB681	CAP 680PF 50V CERAMIC X7R 0805	680pf	C0805	0	50V	311-1126-1-ND	Digikey	
7	300-00040	5	CAP	C14 C23 C24 C25	MURATA	GRM188R71C103KA01D	CAP CER 10000PF 16V 10% X7R 0603	10nF	C0603	0	16V	490-1525-2-ND	Digikey	
8	300-00036	2	CAP	C15 C54	Taiyo Yuden	UMK107BJ105KA-T	Cap Ceramic SMT 0603	1uF	C0603	0	50V	587-2400-1-ND	Digikey	
9	300-00041	2	CAP	C16 C17	MURATA	GRM155F51E104ZA01D	CAP CER .1UF (100nF) 25V Y5V 0402	100nF	C0402	0	25V	490-3271-1-ND	Digikey	
10	300-00043	2	CAP	C18 C19	MURATA	GRM188R71E103KA01D	CAP CER 10000PF (10NF) 25V 10% X7R 0603	10nF	C0603	0	25V	490-1520-1-ND	Digikey	
11	300-00039	2	CAP	C20 C30	Taiyo Yuden	GMK316F106ZL-T	Cap Ceramic SMT 1206	100UF	C1206	0	35V	587-1352-1-ND	Digikey	
12	300-00042	1	CAP	C21	TDK	C5750Y6V1E476Z	CAP CER 47UF 25V Y5V 2220	47uF	C2220	0	25V	445-3486-2-ND	Digikey	
13	300-00014	1	CAP	C22	Kemet Electronics Corporation	C0402C104K8PACTU	Cap Ceramic SMT 0402	100nF	C0402	0	10V	399-3027-2-ND	Digikey	
14	300-00008	1	CAP	C26	PANASONIC	ECJ-2FB0J106M	Capacitor 10UF 6.3 V 20 % X5R	10UF	C0805	0.2	6.3V			
15	300-00037	1	CAP	C27	AVX	06035C103KAT2A	Cap Ceramic SMT 0603	10nF	C0603	0	50V	478-1227-1-ND	Digikey	
16	300-00028	1	CAP	C28			Cap Ceramic SMT 0402	33nF	C0402	0				
17	300-00026	1	CAP	C29			Cap Ceramic SMT 0402	22nF	C0402	0				
18	300-00011	2	CAP	C31 C42	PANASONIC	ECJ-1VB0J106M	CAP CERAMIC 10UF 6.3V X5R 0603	10UF	C0603	20%	10V	rPCC2395CT-ND	Digikey	
19	300-00012	4	CAP	C32 C35 C43 C44	Vishay	298D476X0010P2T	CAP TANT 47UF 10V 20% 0805	47UF	C0805P	0	10V	718-1608-1-ND	Digikey	
20	300-00044	14	CAP	C38 C39 C40 C41 C45 C46 C47 C48 C49 C50	MURATA	GRM155R61A104KA01D	CAP CER .1UF 10V 10% X5R 0402	0.1uf	C0402	0	10V	490-1318-1-ND	Digikey	
21	300-00057	3	CAP	C55 C61 C62			Cap Ceramic SMT 0402	DNI	DNI	0				Do Not Install
22	300-00063	1	CAP	C56	TDK	C1005X5R0G475K	CAP CER 4.7UF 4.0V X5R 10% 0402	DNI	DNI	0	4V	445-5949-1-ND	Digikey	Do Not Install
23	300-00062	1	CAP	C57	Johanson Dielectrics Inc	250R07S330JV4T	CAP CER 33PF 25V S 0402 UHI Q	DNI	DNI	0	25V	712-1298-1-ND	Digikey	Do Not Install
24	300-00064	1	CAP	C58	TDK	C1608X5R0J106M	CAP CER 10UF 6.3V X5R 20% 0603	DNI	DNI	0	6.3	445-4112-1-ND	Digikey	Do Not Install
25	200-00010	2	FET DIODE	D1 D2	PANASONIC	LNJ208R8ARA	LED, RED, 3.0 VR, 0.2 IF, SURF. MOUNT	LED RED 5MA SMT	LEDO603H35	0				
26	320-00013	1	CONN	J1	Sullins Connector Solutions	SBH31-NBPB-D17-SP-BK	CONN HDR 1.27MM 34POS GOLD SMD	CONN HDR 1.27MM 34POS GOLD SMD	SBH31-NBPB-D17-SP-BK	male		S9108-ND	Digikey	
27	120-00068	1	CONN	J2	SAMTEC	TSM-107-01-S-DV	CONN. 2X7 HEADER, SMT, DSP JTAG, Pin 6 removed	DSP JTAG Header	hdr 14p	0				
28	330-00009	1	MAGNETICS	L1	Panasonic - ECG	ELJ-EA331KF	INDUCTOR 330UH 10% 1210 SMD	330uH	IND1210	0		PCD1432CT	Digikey	
29	330-00010	1	MAGNETICS	L2	Taiyo Yuden	CB2518T471K	INDUCTOR POWER 470UH 1007	470uH	IND1007	0		587-2194-1-ND	Digikey	
30	330-00011	1	MAGNETICS	L3	Taiyo Yuden	LB3218T1R0M	INDUCTOR 1.0UH 1.075A 20% SMD	1uH	IND1207	0		587-2032-1-ND	Digikey	
31	330-00021	1	MAGNETICS	L4	TDK	GLCR2012T2R2M-HC	INDUCTOR 2.2UH 350MA 20% 0805	DNI	DNI	0	350mA	445-3625-1-ND	Digikey	Do Not Install
32	490-00002	1	Heat Sink	P1			DNI	DNI	0					Do Not Install
33	310-00041	2	RES	R1 R2			Resistors 56R, 5% - SMD_0402	56R	R0402	0.05				
34	310-00035	2	RES	R3 R4			Resistors, 1K 5%, SMD_0402	1K	R0402	0				
35	310-00011	2	RES	R5 R6			Resistors, 680R, 5% - SMD_0603	680R	R0603	0.05				
36	310-00042	2	RES	R7 R8			Resistors 5K49 5% - SMD_0402	5K49	R0402	0				
37	310-00043	1	RES	R9			Resistors 2K 5% - SMD_0402	2K	R0402	0				
38	310-00044	2	RES	R10 R11			Resistors 57K6 5% - SMD_0402	57K6	R0402	0				
39	310-00045	3	RES	R12 R13 R14			Resistors 2K2 5% - SMD_0402	2K2	R0402	0				
40	310-00029	3	RES	R15 R28 R29			Resistors, 0R, 5% - SMD_0402	0R	R0402	0				
41	310-00049	7	RES	R16 R17 R18 R19 R20 R21 R22			Resistor 10K 5% - SMD_0402	10K	R0402	0				
42	310-00063	1	RES	R23	Vishay	CRCW0402330RJNED	RES 330 OHM 1/16W 5% 0402 SMD	330R	R0402	0		541-330JCT-ND	Digikey	
43	310-00051	2	RES	R24 R25			Resistor 150R 5% - SMD_0402	150R	R0402	0				
44	310-00030	3	RES	R33 R34			Resistors, DNP - SMD_0402 (do not populate)	DNP	R0402	0				
45	110-00230	2	RES	R30 R31			Resistors DNP - SMD_0603 (Do NOT populate)	DNP	R0603	0				
46	310-00067	1	RES	R32			Resistor 33K 5% - SMD_0402	33K	R0402	0				
47	310-00090	1	RES	R35	Panasonic	ERJ-2RKF3573X	RES 357K OHM 1/10W 1% 0402 SMD	DNI	DNI	0		P357KCLCT-ND	Digikey	Do Not Install
48	310-00091	1	RES	R36	Panasonic	ERJ-2RKF1653X	RES 165K OHM 1/10W 1% 0402 SMD	DNI	DNI	0		P165KCLCT-ND	Digikey	Do Not Install
49	310-00102	2	RES	R41 R42	Panasonic - ECG	ERJ-2GE0R00X	RES 0.0 OHM 1/10W 0402 SMD	0	R0402	0		PO.0JCT-ND	Digikey	
50	310-00104	1	RES	R43	Panasonic	ERJ-2GEJ103X	RES 10K OHM 1/10W 5% 0402 SMD	DNP	R0402	0				
51	206-00010	1	SWITCH	SW1	CTS	218-21PST	SWITCH DIP HALF PITCH 2POS	2POS DIPSW	SMT218LP_2POS	0		CT2182LPST-ND	Digikey	
52	280-00005	4	MTG HOLE TP	TP1 TP3 TP4 TP5	TI	5015	PC TEST POINT MINIATURE SMT	TP CLIP 5015	TP_5015	0				
53	400-00003	2	FET DIODE	U10 U9	Diodes Inc	B350A-13-F	DIODE SCHOTTKY 3A 50V SMA	B350A-13-F	DO-214AB	0		B350A-FDICT-ND	Digikey	
54	400-00007	1	FET DIODE	U11	On Semi	15MB5931BT3	DIODE ZENER 3W 18V SMB	18V	DO-214AA	0		15MB5931BT3GOSCT-ND	Digikey	
55	402-00037	1	IC	U12	TI	TPS62240	2.25 MHz 300 mA Step Down Converter	DNI	DNI	0				Do Not Install
56	402-00034	1	IC	U1	TI	F2806x	F28069, 80-Pin PFP LQFP	F2806x 80Pin	PFP (80)	0				
57	402-00027	1	IC	U2	Atmel	AT24C1024B-TH-T	IC EEPROM 1MBIT 1MHZ 8TSSOP	DNI	DNI	0				DNP
58	402-00005	1	IC	U3	TI	SN74LVC2G07DBV	IC Dual Buffer/Driver With Open-Drain Outputs, SOT23-6	DBV6	DBV6	0		296-13494-2	Digikey	
59	203-00037	1	POWER	U4	TI	TPS3828-33DBV	Reset Supervisor, SOT23-5	TPS3828	DBV5	0		296-2638-1	Digikey	
60	402-00028	1	IC	U6	TI	AFE031	AFE031 TI PLC Integrated AFE, 48 pin QFN RGZ	AFE031	RGZ	0				
61	400-00027	2	FET DIODE	U7 U8	Diodes Inc	DNI	Do Not Install	DNI	DO-214AB	0		4-SMD (0.197" L x 0.126" W)		
62	405-00009	1	OSC XTAL	X1	Abracon Corporation	ABM3B-20.000MHZ-10-1-U-T	CRYSTAL 20.000MHZ 10PF SMD	20Mhz OSC 20ppm		0		300-8214-1-ND	Digikey	
63	310-00030	3	RES	R27			Resistors, DNP - SMD_0402 (do not populate)	10K	R0402	0		P10KJTR-ND	Digikey	

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